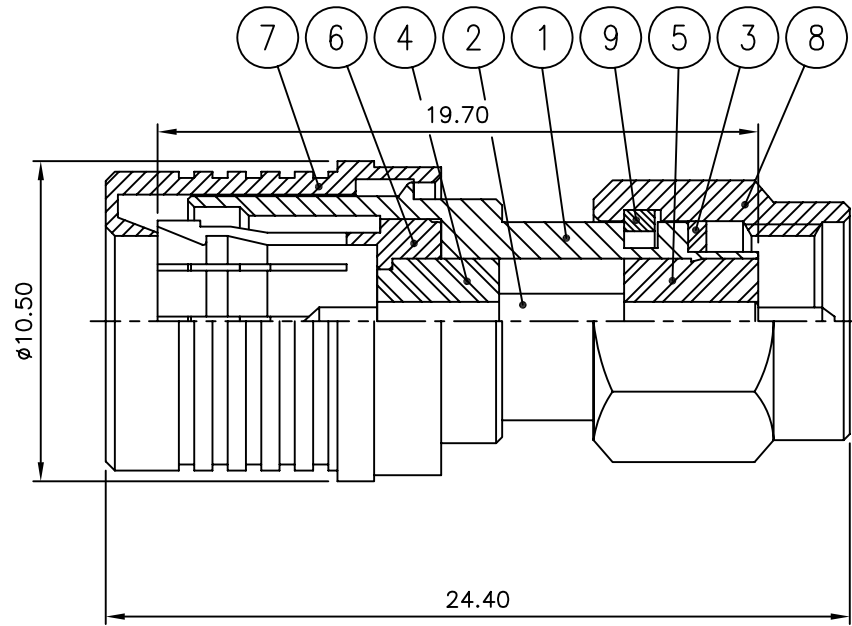
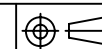


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	M.H.SONG	I.C.KIM	2013.12.31.
1	[설번No.201806-0002] QMA 표준화 치수 변경	S.Y.EUN	I.C.KIM	2018.06.13.



9	SPRING RING	1	SUS	Passivate	DSR00002-5/1
8	COUPLING CAP	1	MBsBD	Nickel Plate	DCU00005-5/2
7	CAP	1	MBsBD	Nickel Plate	DCU00089-5/2
6	JACK	1	BeCu	Nickel Plate	DJA00209-5/3 DJA00070-5/2
5	INSULATOR	1	TEFLON		DIN00138-N/2
4	INSULATOR	1	TEFLON		DIN01539-N/1
3	GASKET	1	SILICONE Rub		DGK00004-N/1
2	CONTACT	1	MBsBD	Gold Plate	DAC00267-5/1
1	BODY	1	MBsBD	Nickel Plate	DAD00269-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2018. 06. 13.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE KQMA50 (P) SMA50 (P) AD
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	4/1	DWG NO. AD00510-7/2 REVISION 1 SHEET 1 of 1
		UNIT	mm	



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